



Date of 2019 Annual General Meeting

San Luis Obispo, California – 29 January 2019: Revasum, Inc. (ASX: RVS, 'Revasum' or the 'Company') advises that, pursuant to ASX Listing Rule 3.13.1 its Annual General Meeting will be held on Monday, 20 May 2019 in Sydney, Australia.

Further details will be provided in the Notice of Meeting which will be provided to security holders in due course.

About Revasum

Revasum (ARBN: 629 268 533) manufactures market-leading wafer processing equipment for the global semiconductor industry at 200mm and below. Its portfolio of production proven, reliable CMP, grinding and polishing equipment supports device and substrate producers in critical growth markets including IoT, 5G, and automotive. Revasum's products serve a broad range of market segments such as silicon, silicon carbide, power, RF communications, LED, MEMS, semiconductor and other mobile applications. Revasum's equipment and processes are designed and developed in close collaboration with its customers. As a result, each system meets or exceeds customer's requirements for quality, performance, and cost.

For more information, www.revasum.com.

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